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300		MITTAL	LETT	ER			Case No	. 7103-261 (P	0704
Serial No 100/843,323	Pling Date				Examiner		Group A	rt Unit 372し	<i>į</i>
Inventor(s) Allan M. Radman							D		
Title of Invention							T)		
SPHERICAL CAP-SHAPED SEMICONDUCTOR WAFERS	POLISHING	HEAD	IN	Α	CHEMICAL	MECHANICAL	POLISHING	APPARATUS AR X 7 20	
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TECHNOLOGY CENTER P3700 Transmitted herewith is Trans. Ltr. (1p) in dupl.; Information Disclosure Statement (2p); PTO Form 1449 (1p) Cited Refs. x8 Return PostCard.												
	Small entity status of this application under 37 CFR § 1.27 has been established by verified statement previously submitted.											
	A verified state	ement to est	ablish small entit	y status under 3	37 CFR §§ 1.9	and 1.27 is	enclose	REC	EIVI	ED		
	A verified statement to establish small entity status under 37 CFR §§ 1.9 and 1.27 is enclosed. RECEIVE Petition for amonth extension of time. FEB 2 8 2002									UL.		
\boxtimes	No additional fee is required.							TECHNOLOGY CENTER ROTOO				
	The fee has been calculated as shown below:								i			
					Smal	Small Entity Small Entity Small Entity						
	Claims Remaining After Amendment		Highest No. Previously Paid For	Present Extra	Rate	Add'I Fee	or.	Rate	Add'l Fee			
Total		Minus			x \$9=	-		x \$18=				
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First Pre	sentation of Mul	tiple Dep. Cl	aim		+ \$130 =		<u> </u>	+ \$260=				
					Total add'l fee	\$		total add'l fee	\$			
	Please charge Deposit Account No. 23-1925 (BRINKS HOFER GILSON & LIONE) in the amount of \$ A duplicate copy of this sheet is enclosed.											
	A check in the amount of \$ to cover the filing fee is enclosed.											
\boxtimes	The Assistant Commissioner is hereby authorized to charge payment of any additional filing fees required under 37 CFR § 1.16 and any patent application processing fees under 37 CFR § 1.17 associated with this communication or credit any overpayment to Deposit Account No. 23-1925. A duplicate copy of this sheet is enclosed.											
	•			Respectfully	y submitted,				•			
	.•		/	Linda D. Ke	ennedy C		~					
			L	,	No. 44,183							
P.O. BO	HOFER GILSON X 10395 O, ILLINOIS 606 21-4200			, ittorio, io	, , , pp. out.							
I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, with sufficient postage, in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on												
7/20/1												
Date:	2 / 26 / 1	2/_ Signatur	e:	V 6		- 2		_				
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